

HMC400MS8 / 400MS8E

v02.0705





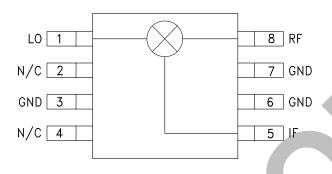
HIGH IP3 GaAs MMIC MIXER, 1.7 - 2.2 GHz

Typical Applications

High Dynamic Range Infrastructure:

- GSM, GPRS & EDGE
- CDMA & W-CDMA
- Cable Modem Termination Systems

Functional Diagram



Features

Input IP3: +35 dBm

Conversion Loss: 8.8 dB

No External Components

Ultra Small MSOP Package: 14.8mm²
Included in the HMC-DK003 Designer's Kit

General Description

The HMC400MS8(E) is a high dynamic range passive MMIC mixers in plastic surface mount 8 lead Mini Small Outline Packages (MSOP) covering 1.7 to 2.2 GHz. Excellent input IP3 performance of +36 dBm for down conversion and +29 dBm for up conversion is provided for 2.5G & 3G GSM/CDMA based UMTS or PCS applications at an LO drive of +17 dBm. With a 1 dB compression of +21 dBm, the RF port will accept a wide range of input signal levels. Conversion loss is 8.5dB typical and LO isolations are maintained at 22 to 33 dB. This miniature single-ended monolithic GaAs FET mixer does not require any external components or bias. The 50 to 300 MHz IF frequency response will satisfy many UMTS/PCS transmit or receive frequency plans configured for low side LO. The HMC400MS8(E) input IP3 performance coupled with its high P1dB rivals traditional active FET mixers while offering a much smaller 14.8mm² standard IC footprint and no DC bias.

Electrical Specifications, $T_A = +25^{\circ}\text{C}$, LO = +17 dBm, IF = 200 MHz*

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, RF	1.7 - 1.8		1.8 - 2.0		2.0 - 2.2		GHz			
Frequency Range, LO		1.4 - 1.75		1.5 - 1.95		1.7 - 2.15		GHz		
Frequency Range, IF	DC - 300 DC - 300 DC - 300			MHz						
Conversion Loss		9	11		8.8	10.5		8.8	10.5	dB
Noise Figure (SSB)		9	11		8.8	10.5		8.8	10.5	dB
LO to RF Isolation	29	33		24	30		20	25		dB
LO to IF Isolation	16	20		17	22		19	25		dB
IP3 (Input)	30	34		32	36		28	32		dBm
1 dB Gain Compression (Input)	18	21		18	21		18	22		dBm
LO Input Drive Level (Typical)	+16 to +18		+16 to +18		+16 to +18		dBm			

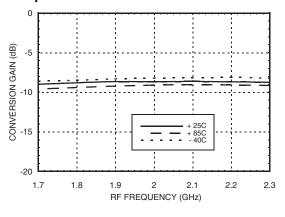
^{*}Unless otherwise noted, all measurements performed as a downconverter, with low side LO & IF = 200 MHz.



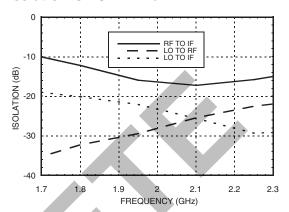


HIGH IP3 GaAs MMIC MIXER, 1.7 - 2.2 GHz

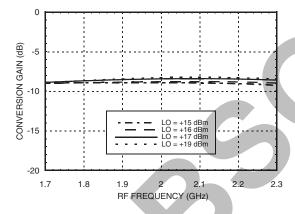
Conversion Gain vs.
Temperature @ LO = +17 dBm



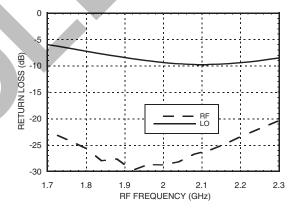
Isolation @ LO = +17 dBm



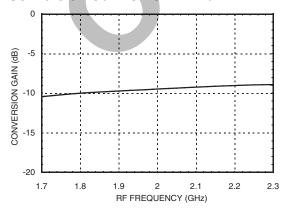
Conversion Gain vs. LO Drive



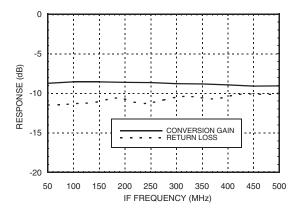
Return Loss @ LO = +17 dBm



Upconverter Performance Conversion Gain @ LO = +17 dBm



If Bandwidth @ LO = +17 dBm



*Unless otherwise noted, all measurements performed as a downconverter, with low side LO & IF = 200 MHz.

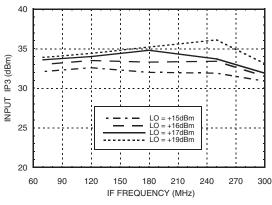
HIGH IP3 GaAs MMIC MIXER, 1.7 - 2.2 GHz



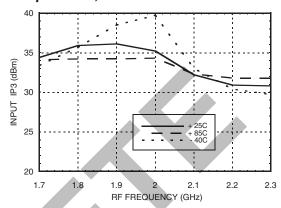
v02.0705



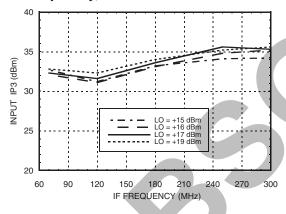
Input IP3 vs. IF Frequency, RF = 1.75 GHz



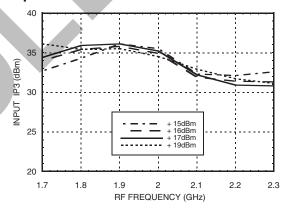
Input IP3 vs. Temperature, LO = +17 dBm



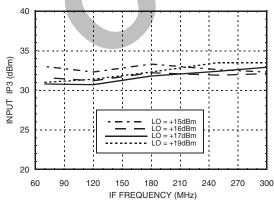
Input IP3 vs.
IF Frequency, RF = 1.95 GHz



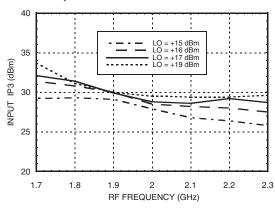
Input IP3 vs. LO Drive



Input IP3 vs. IF Frequency, RF = 2.15 GHz



Upconverter IP3 vs. LO Drive, IF = 200 MHz



*Unless otherwise noted, all measurements performed as a downconverter, with low side LO & IF = 200 MHz.



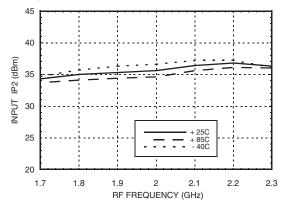
HMC400MS8 / 400MS8E

v02.0705

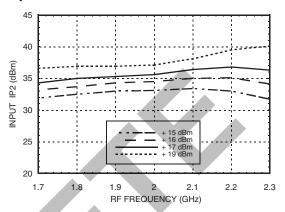


HIGH IP3 GaAs MMIC MIXER, 1.7 - 2.2 GHz

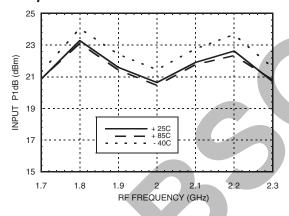
Input IP2 vs. Temperature @ LO = +17 dBm



Input IP2 vs. LO Drive @ LO = +17 dBm



Input P1dB vs. Temperature @ LO = +17 dBm



MxN Spurious Outputs

				nLO		
	mRF	0	1	2	3	4
	0	xx	-11	7	4	8
l	1	9	0	24	31	27
	2	71	70	49	58	64
	3	79	80	80	79	77
	4	77	80	80	79	80

RF Freq = 2 GHz @ -10 dBm

LO Freq = 1.8 GHz @ +17 dBm

All values in dBc relative to the IF output power.

Harmonics of LO

		nLO Spur @ RF Port		
LO Freq (GHz)	1	2	3	4
1.4	42	26	56	46
1.55	33	25	56	53
1.7	29	29	49	50
1.85	26	31	44	53
2	24	36	44	48
2.15	21	38	43	49
10 17 10				

LO = +17 dBm All values are in dBc below input LO level @ RF port.

Absolute Maximum Ratings

RF/IF Input	+27 dBm
LO Drive	+27 dBm
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
IF DC Current	±40 mA



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

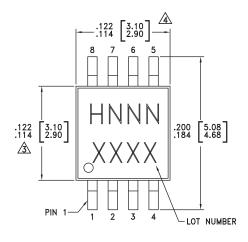
*Unless otherwise noted, all measurements performed as a downconverter, with low side LO & IF = 200 MHz.

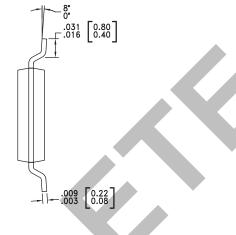


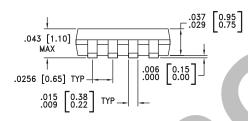


HIGH IP3 GaAs MMIC MIXER, 1.7 - 2.2 GHz

Outline Drawing







NOTES

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- 4 DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC400MS8	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H400 XXXX
HMC400MS8E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H400 XXXX

- [1] Max peak reflow temperature of 235 $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260 $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX





HIGH IP3 GaAs MMIC MIXER, 1.7 - 2.2 GHz

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	LO	This pin is AC coupled & matched to 50 Ohms from 1.4 to 2.2 GHz. Blocking capacitors are required if line potential is not equal to 0V.	
2, 4	N/C	Not connected.	
3, 6, 7	GND	This pin must be connected to RF ground.	Ç GND
5	IF Port	This pin is DC coupled. For applications not requiring operation to DC this port should be DC blocked externally using a series capacitor. Choose value of capacitor to pass IF frequency desired. For operation to DC, this pin must not sink/source more than 40 mA of current or failure may result.	- F
8	RF Port	This pin is DC coupled & matched to 50 Ohm from 1.7 to 2.2 GHz	RF O

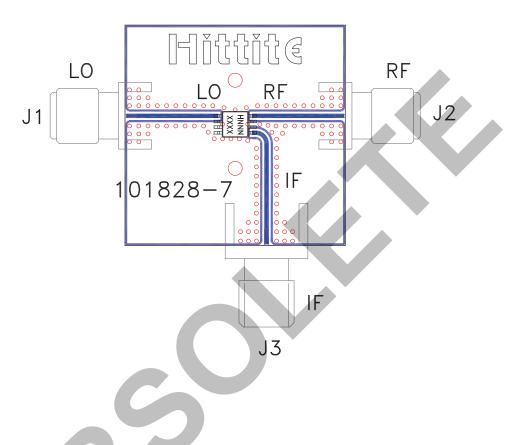






HIGH IP3 GaAs MMIC MIXER, 1.7 - 2.2 GHz

Evaluation PCB



List of Materials for Evaluation PCB 101830 [1]

Item	Description			
J1 - J3	PCB Mount SMA RF Connector			
U1	HMC400MS8 / HMC400MS8E Mixer			
PCB [2]	101828 Eval Board			

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

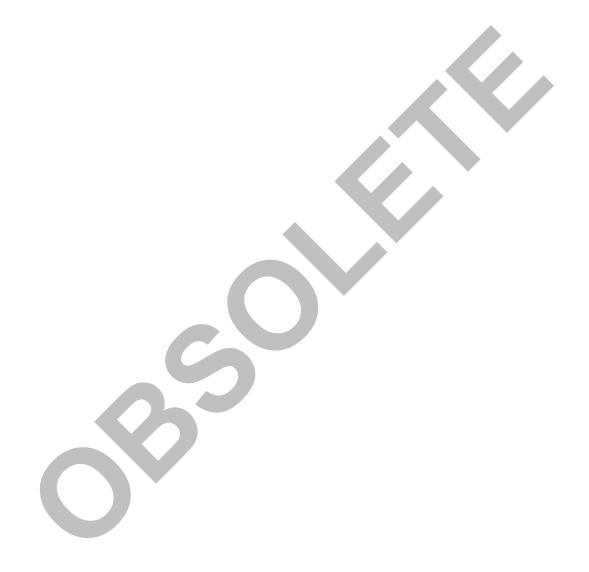
The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.





Notes:

HIGH IP3 GaAs MMIC MIXER, 1.7 - 2.2 GHz



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Mixer category:

Click to view products by Analog Devices manufacturer:

Other Similar products are found below:

 HMC337-SX
 HMC404-SX
 mamx-009646-23dbml
 HMC339-SX
 HMC8192-SX
 MIQ24MS-2
 HMC220BMS8GETR
 M85C
 HMC554A-SX

 HMC8192LG
 HMC521A-SX
 HMC521ACHIPS
 CMD258C4
 LT5511EFE
 MAMX-011023-SMB
 HMC399MS8TR
 HMC333TR

 HMC214MS8TR
 HMC175MS8TR
 MAMXSS0012TR-3000
 109728-HMC129LC4
 CSM1-13
 SA612AD/01.112
 HMC785LP4ETR

 LT5579IUH#PBF
 HMC773ALC3BTR
 HMC558ALC3B
 HMC329ALC3B
 MY63H
 AD8343ARUZ-REEL7
 AD608AR
 AD608AR

 AD831APZ
 AD831APZ-REEL7
 AD8342ACPZ-REEL7
 AD8343ARUZ
 AD8344ACPZ-REEL7
 ADL5350ACPZ-R7
 ADL5363ACPZ-R7

 ADL5365ACPZ-R7
 ADL5801ACPZ-R7
 ADL5802ACPZ-R7
 HMC1056LP4BE
 HMC1057-SX
 HMC1063LP3E
 HMC1093-SX
 HMC1106-SX

 SX
 HMC129
 HMC143
 HMC400MS8ETR